



## Material Content Data Sheet



<b>Sales Product Name</b>				SAK-TC297TX-128F300N BC		<b>Issued</b>		30. July 2019	
<b>MA#</b>				MA005350595					
<b>Package</b>				PG-LFBGA-292-6		<b>Weight*</b>		940.68 mg	
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	52.040	5.53	5.53	55322	55322	
wire	noble metal	palladium	7440-05-3	0.014	0.00		15		
	non noble metal	copper	7440-50-8	1.407	0.15	0.15	1496	1511	
encapsulation	organic material	carbon black	1333-86-4	0.652	0.07		693		
	plastics	epoxy resin	-	45.002	4.78		47840		
	inorganic material	silicondioxide	60676-86-0	280.446	29.82	34.67	298131	346664	
substrate	plastics	epoxy resin	-	6.479	0.69		6887		
	inorganic material	bariumsulfate	7727-43-7	9.942	1.06		10569		
	plastics	acrylic resin	-	11.506	1.22		12231		
	inorganic material	aluminiumhydroxide	21645-51-2	53.265	5.66		56625		
	plastics	epoxy bismaleimide triazine resin	-	61.156	6.50		65013		
	inorganic material	glass fibre	-	82.857	8.81		88083		
	non noble metal	copper	7440-50-8	196.577	20.90	44.84	208974	448382	
plating	noble metal	gold	7440-57-5	1.106	0.12		1176		
	non noble metal	nickel	7440-02-0	3.027	0.32	0.44	3218	4394	
solderball	noble metal	silver	7440-22-4	4.457	0.47		4739		
	non noble metal	tin	7440-31-5	122.898	13.06	13.53	130649	135388	
glue	plastics	epoxy resin	-	1.961	0.21		2085		
	noble metal	silver	7440-22-4	5.883	0.63	0.84	6254	8339	
*deviation	< 10%			Sum in total:		100.00		1000000	

### Important Remarks:

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